





# FSA2467 0.4Ω Low-Voltage Dual DPDT Analog Switch

#### **Features**

- Typical 0.4Ω On Resistance (R<sub>ON</sub>) for +2.7V supply
- Features Less then12μA IccT Current when Sn Input is Lower than V<sub>CC</sub>
- 0.25Ω Maximum R<sub>ON</sub> Flatness for +2.7V Supply
- 3x3mm 16-Lead Pb-Free MLP Package
- 1.8x2.6mm 16-Lead Pb-Free UMLP Package
- Broad V<sub>CC</sub> Operating Range
- Low THD (0.02% Typical for 32Ω Load)

### **Applications**

- Cell Phone
- PDA
- Portable Media Player

### **Description**

The FSA2467 is a dual Double-Pole, Double-Throw (DPDT) analog switch. The FSA2467 operates from a single 1.65V to 4.3V supply. The FSA2467 features an ultra-low on resistance of  $0.4\Omega$  at a +2.7V supply and 25°C. This device is fabricated with sub-micron CMOS technology to achieve fast switching speeds and is designed for break-before-make operation.

FSA2467 features very low quiescent current even when the control voltage is lower than the  $V_{\rm CC}$  supply. This feature allows mobile handset applications direct interface with baseband processor general-purpose I/Os.

### **Ordering Information**

| Part Number | Package Description   |
|-------------|---|
| FSA2467MPX  | 16-lead Molded Leadless Package (MLP), JEDEC MO-220, 3x3mm Square |
| FSA2467UMX  | 16-lead Ultrathin Molded Leadless Package (UMLP), 1.8x2.6mm       |

All packages are lead free per JEDEC: J-STD-020B standard.

# **Application Diagram**

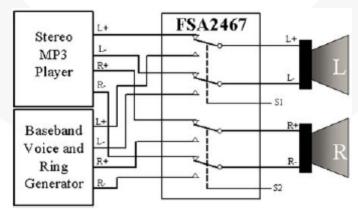


Figure 1. Application Diagram

# **Pin Assignments**

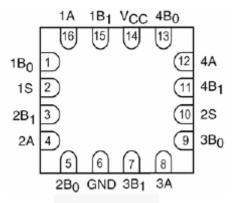


Figure 2. Pin Assignments

#### **Truth Table**

| Control Inputs | Function                        |
|----------------|---------------------------------|
| LOW            | nB <sub>0</sub> Connected to nA |
| HIGH           | nB <sub>1</sub> Connected to nA |

# **Pin Descriptions**

| Name                                | Function      |
|-------------------------------------|---------------|
| nA,nB <sub>0</sub> ,nB <sub>1</sub> | Data Ports    |
| nS                                  | Control Input |

# **Analog Symbol**

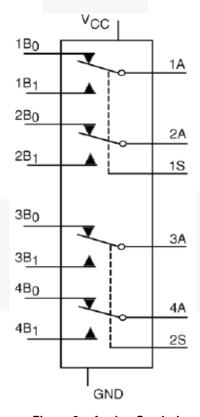


Figure 3. Analog Symbol

# **Absolute Maximum Ratings**

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only.

| Symbol              | Parameter   | Min. | Max.                 | Unit |
|---------------------|---|------|----------------------|------|
| V <sub>CC</sub>     | Supply Voltage  | -0.5 | 4.6                  | V    |
| Vs                  | Switch Voltage  | -0.5 | V <sub>CC</sub> +0.3 | V    |
| V <sub>IN</sub>     | Input Voltage   | -0.5 | 4.6                  | V    |
| I <sub>IK</sub>     | Input Diode Current   | -50  |                      | mA   |
| I <sub>SW</sub>     | Switch Current  |      | 350                  | mA   |
| I <sub>SWPEAK</sub> | Peak Switch Current (Pulsed at 1ms duration, <10% Duty Cycle) |      | 500                  | mA   |
| T <sub>STG</sub>    | Storage Temperature Range                                     | -65  | +150                 | °C   |
| TJ                  | Junction Temperature  |      | +150                 | °C   |
| TL                  | Lead Temperature, Soldering 10 Seconds                        |      | +260                 | °C   |
| ESD                 | Human Body Model  |      | 5.5                  | kV   |

# **Recommended Operating Conditions**

The Recommended Operating Conditions table defines the conditions for actual device operation. Recommended operating conditions are specified to ensure optimal performance to the datasheet specifications. Fairchild does not recommend exceeding them or designing to Absolute Maximum Ratings.

| Symbol          | Parameter                            | Min. | Max.            | Unit |
|-----------------|--------------------------------------|------|-----------------|------|
| $V_{CC}$        | Supply Voltage                       | 1.65 | 4.30            | V    |
| V <sub>IN</sub> | Control Input Voltage <sup>(1)</sup> | 0    | V <sub>CC</sub> | V    |
| V <sub>IN</sub> | Switch Input Voltage                 | 0    | V <sub>CC</sub> | V    |
| T <sub>A</sub>  | Operating Temperature                | -40  | +85             | °C   |

#### Note:

1. Unused inputs must be held HIGH or LOW. They may not float.

### **DC Electrical Characteristics**

Typical values are at 25°C unless otherwise specified.

| Symbol               | Parameter                               | Conditions  | V <sub>cc</sub> (V) | T <sub>A</sub> = +25°C |      |      | T <sub>A</sub> = -40 to<br>+85°C |      | Units |  |
|----------------------|---|---|---------------------|------------------------|------|------|----------------------------------|------|-------|--|
|                      | i alamotol                              | Containing  | Min. Typ.           |                        | Max. | Min  | Max.                             |      |       |  |
|                      |   |   | 4.3                 |                        |      |      | 1.4                              |      |       |  |
| V <sub>IH</sub> In   | Input Voltage High                      |   | 2.7 to 3.6          |                        |      |      | 1.3                              |      | V     |  |
| V IH                 | input voltage riigii                    |   | 2.3 to 2.7          |                        |      |      | 1.1                              |      | V     |  |
|                      |   |   | 1.65 to 1.95        |                        |      |      | 0.9                              |      |       |  |
|                      |   |   | 4.3                 |                        |      |      |                                  | 0.7  |       |  |
| \ /                  | Innut Valtage Laur                      |   | 2.7 to 3.6          |                        |      |      |                                  | 0.5  | \ /   |  |
| $V_{IL}$             | Input Voltage Low                       |   | 2.3 to 2.7          |                        |      |      |                                  | 0.4  | V     |  |
|                      |   |   | 1.65 to 1.95        |                        |      |      |                                  | 0.4  |       |  |
| I <sub>IN</sub>      | Control Input Leakage                   | V <sub>IN</sub> =0V to V <sub>CC</sub>  | 1.65 to 4.30        |                        |      |      | -0.5                             | 0.5  | μA    |  |
| I <sub>NO(OFF)</sub> | Off Leakage Current of                  | nA=0.3V,<br>V <sub>CC</sub> -0.3V   |                     |                        |      |      |                                  |      |       |  |
| I <sub>NC(OFF)</sub> | Port nB₀ and nB₁                        | $nB_0$ or $nB_1$ =0.3V, $V_{CC}$ -0.3V or floating                                  | 1.95 to 4.30 -      | -10.0                  |      | 10.0 | -50.0                            | 50.0 | nA    |  |
|                      | On Leakage Current of                   | nA=0.3V,V <sub>CC</sub> -<br>0.3V   |                     | -10.0                  |      | 40.0 |                                  |      |       |  |
| I <sub>A(ON)</sub>   | Port A                                  | $nB_0$ or $nB_1$ =0.3V, $V_{CC}$ -0.3V or floating                                  | 1.95 to 4.30        |                        |      | 10.0 | -50.0                            | 50.0 | nA    |  |
|                      |   | I <sub>OUT</sub> =100mA   | 4.3                 |                        | 0.4  |      |                                  | 0.6  |       |  |
|                      |   | nB <sub>0</sub> or<br>nB <sub>1</sub> =0V,0.8V,<br>1.8V,2.7V                        | 2.7                 |                        | 0.4  |      |                                  | 0.6  |       |  |
| R <sub>ON</sub>      | Switch On Resistance <sup>(2)</sup>     | I <sub>OUT</sub> =100mA, nB <sub>0</sub><br>or <sub>1</sub> =0V,0.7V,<br>1.2V, 2.3V | 2.3                 | 0.55                   |      |      |                                  | 0.95 | Ω     |  |
|                      |   | $I_{OUT}$ =100mA, nB <sub>0</sub> or nB <sub>1</sub> =1.0V                          | 1.8                 | 0.8                    |      |      |                                  | 2.0  | 1     |  |
| $\Delta R_{ON}$      | On Resistance Matching                  | $I_{OUT}$ =100mA, nB <sub>0</sub> or nB <sub>1</sub> =0.8V                          | 2.7                 | 0.04                   |      |      |                                  | 0.10 | Ω     |  |
| ΔNON                 | Between Channels <sup>(3)</sup>         | $I_{OUT}$ =100mA, nB <sub>0</sub> or nB <sub>1</sub> =0.7V                          | 2.3                 | 0.03                   |      |      |                                  | 0.10 | 7.2   |  |
| D                    | On Resistance Flatness <sup>(4)</sup>   | I <sub>OUT</sub> =100mA, B <sub>0</sub>   | 2.7                 |                        |      |      |                                  | 0.25 | -     |  |
| $R_{FLAT(ON)}$       | On Resistance Flatness**                | or nB <sub>1</sub> =0V to V <sub>CC</sub>   | 2.3                 |                        |      |      |                                  | 0.3  | Ω     |  |
| I <sub>cc</sub>      | Quiescent Supply Current                | $V_{IN}$ =0V to $V_{CC}$<br>$I_{OUT}$ =0V   | 4.3                 | -100                   |      | 100  | -500                             | 500  | nA    |  |
|                      | Increase in I <sub>CC</sub> Current per | V <sub>IN</sub> =1.8V   | 4.3                 |                        | 7.0  | 12.0 |                                  | 15.0 |       |  |
| I <sub>CCT</sub>     | Control Voltage                         | V <sub>IN</sub> =2.6V   | 4.3                 |                        | 3.0  | 6.0  |                                  | 7.0  | μΑ    |  |

#### Notes:

- 2. On resistance is determined by the voltage drop between A and B pins at the indicated current through the switch.
- 3.  $\Delta R_{ON} = R_{ON max} R_{ON min}$  measured at identical Vcc, temperature and voltage.
- 4. Flatness is defined as the difference between the maximum and minimum value of on resistance over the specified range of conditions.

# **AC Electrical Characteristics**

Typical values are at 25°C unless otherwise specified.

| Symbol           | Parameter                  | Conditions V <sub>cc</sub>                                |             | 1  | A = +25    | °C   | T <sub>A</sub> = -40 to<br>+85°C |      | Units | Figure       |    |          |
|------------------|----------------------------|---|-------------|--|------------|------|----------------------------------|------|-------|--------------|----|----------|
|                  |                            |   |             | Min.   | Тур.       | Max. | Min.                             | Max. |       |              |    |          |
|                  |                            | nB0 or nB1=1.5V   | 3.6 to 4.3  |  |            | 50   |                                  | 60   |       |              |    |          |
| t <sub>ON</sub>  | Turn-On Time               | $R_L=50\Omega$ , $C_L=35pF$                               | 2.7 to 3.6  |  |            | 65   |                                  | 75   | ns    | Figure 7     |    |          |
|                  |                            |   | 2.3 to 2.7  |  |            | 80   |                                  | 90   |       |              |    |          |
|                  |                            | nB0 or nB1=1.5V   | 3.6 to 4.3  |  |            | 32   |                                  | 40   |       |              |    |          |
| t <sub>OFF</sub> | Turn-Off Time              | $R_L=50\Omega$ , $C_L=35pF$                               | 2.7 to 3.6  |  |            | 42   |                                  | 50   | ns    | Figure 7     |    |          |
|                  |                            |   | 2.3 to 2.7  |  |            | 52   |                                  | 60   |       |              |    |          |
|                  | 4                          | nB0 or nB1=1.5V   | 3.6 to 4.3  |  | 12         |      |                                  |      |       |              |    |          |
| t <sub>BBM</sub> | Break-Before-<br>Make Time | $R_L=50\Omega$ , $C_L=35pF$                               | 2.7 to 3.6  |  | 15         |      |                                  |      | ns    | Figure 8     |    |          |
|                  |                            |   | 2.3 to 2.7  |  | 20         |      |                                  |      |       |              |    |          |
|                  | 7                          | $C_L$ =100pF,<br>$V_{GEN}$ =0V, $R_{GEN}$ =0 $\Omega$     | 3.6 to 4.3  |  | 15         |      |                                  |      |       |              |    |          |
| Q                | Charge Injection           | $C_L$ =100pF,<br>$V_{GEN}$ =0V, $R_{GEN}$ =0 $\Omega$     | 2.7 to 3.6  |  | 10         |      |                                  |      | рС    | Figure<br>10 |    |          |
|                  | 4                          | $C_L$ =100pF,<br>$V_{GEN}$ =0V, $R_{GEN}$ =0 $\Omega$     | 2.3 to 2.7  |  | 8          |      |                                  |      |       |              |    |          |
|                  |                            |   | 3.6 to 4.3  |  | -75        |      |                                  |      |       |              |    |          |
| OIRR             | Off Isolation              | OIRR Off Isolation  |             | f=100KHz,<br>R <sub>i</sub> =50Ω,C <sub>i</sub> =5pF | 2.7 to 3.6 |      | -75                              |      |       |              | dB | Figure 9 |
|                  |                            | , , ,   | 2.3 to 2.7  |  | -75        |      |                                  |      |       |              |    |          |
|                  |                            |   | 3.6 to 4.3  |  | -75        |      |                                  |      |       |              |    |          |
| Xtalk            | Crosstalk                  | f=100KHz,<br>R <sub>L</sub> =50Ω, C <sub>L</sub> =5pF     | 2.7 to 3.6  |  | -75        |      |                                  |      | dB    | Figure 9     |    |          |
|                  |                            |   | 2.3 to 2.7  |  | -75        |      |                                  |      |       |              |    |          |
| BW               | -3dB Bandwidth             | $R_L$ =50 $\Omega$  | 2.3 to 4.3  |  | 85         |      |                                  |      | MHZ   | Figure<br>12 |    |          |
|                  |                            | $R_L$ =32 $\Omega$ , $V_{IN}$ =2 $V_{PP}$ , f=20 to 20kHZ | 3.6 to 4.3  |  | 0.02       |      |                                  |      |       |              |    |          |
| THD              | Total Harmonic Distortion  | $R_L$ =32 $\Omega$ , $V_{IN}$ =2 $V_{PP}$ , f=20 to 20kHZ | 2.7 to 3.6  |  | 0.02       |      |                                  |      | %     | Figure<br>13 |    |          |
|                  |                            | $R_L$ =32 $\Omega$ , $V_{IN}$ =2 $V_{PP}$ , f=20 to 20kHZ | 2.3. to 2.7 |  | 0.02       |      |                                  |      |       |              |    |          |

# Capacitance

| Symbol          | Parameter                     | Conditions | V <sub>cc</sub> | T <sub>A</sub> = +25°C Typical | Units | Figure   |
|-----------------|-------------------------------|------------|-----------------|--------------------------------|-------|----------|
| C <sub>IN</sub> | Control Pin Input Capacitance | f=1MHZ     | 0               | 1.5                            | pF    | Figure 7 |
| $C_{OFF}$       | B Port Off Capacitance        | f=1MHZ     | 3.3             | 32                             | pF    | Figure 7 |
| C <sub>ON</sub> | A Port On Capacitance         | f=1MHZ     | 3.3             | 118                            | pF    | Figure 7 |

# **Typical Applications**

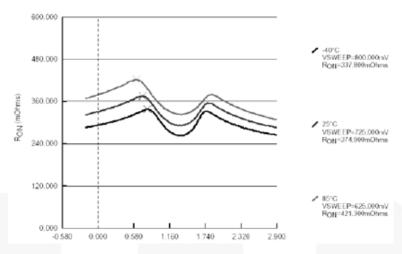


Figure 4.  $R_{ON}$  at 2.7V  $V_{CC}$ 

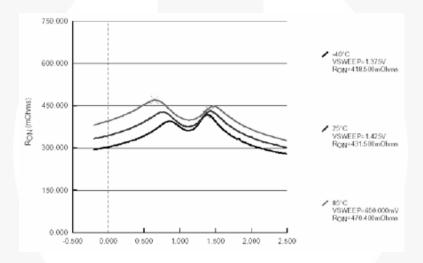
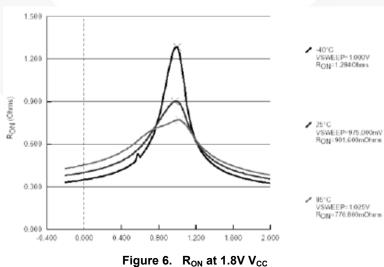
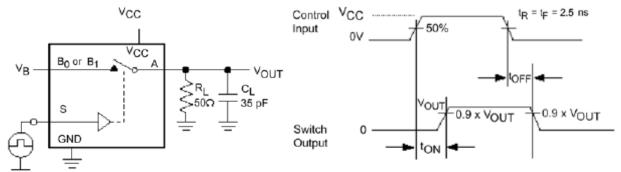


Figure 5. Ron at 2.3V Vcc



## **AC Loadings and Waveforms**



C<sub>1</sub> includes Fixture and Stray Capacitance

Logic Input Waveforms Inverted for Switches that have the Opposite Logic Sense

Figure 7. Turn-On / Turn-Off Timing

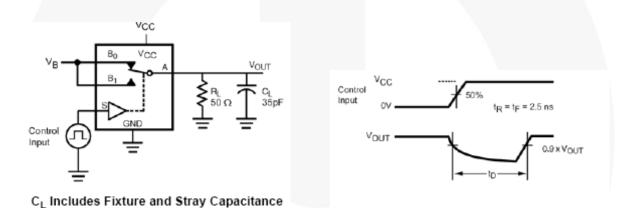


Figure 8. Break-Before-Make Timing

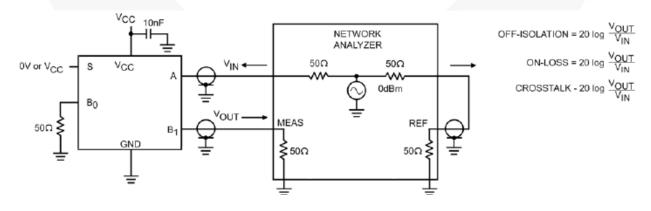


Figure 9. Off Isolation and Crosstalk

# AC Loadings and Waveforms (Continued)

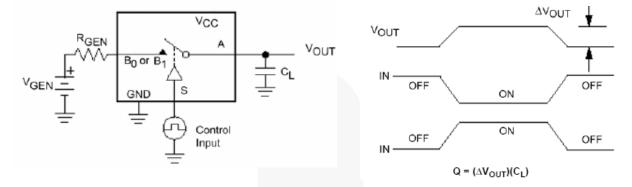


Figure 10. Charge Injection

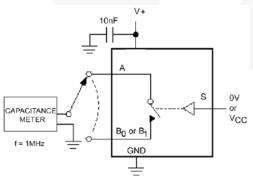


Figure 11. On / Off Capacitance Measurement Setup

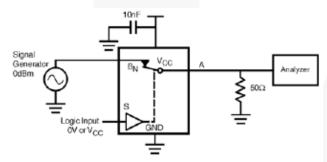


Figure 12. Bandwidth

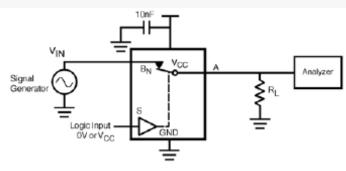
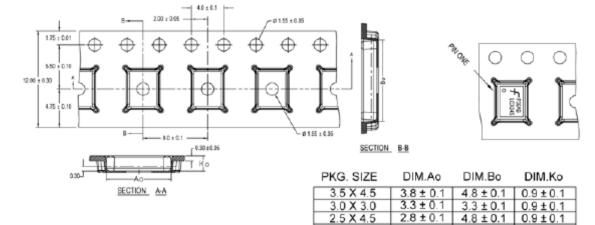


Figure 13. Harmonic Distortion

## **Tape and Reel Specifications**

### **Tape Format for MLP**

| Package Designator | Tape Section       | Number<br>Cavities | Cavity Status | Cover Tape Status |
|--------------------|--------------------|--------------------|---------------|-------------------|
|                    | Leader (Start End) | 125 (typical)      | Empty         | Sealed            |
| MPX                | Carrier            | 2500/3000          | Filled        | Sealed            |
|                    | Trailer (Hub End)  | 75 (typical)       | Empty         | Sealed            |



2.5 X 3.5

DIMENSIONS ARE IN MILLIMETERS

 $3.8 \pm 0.1$ 

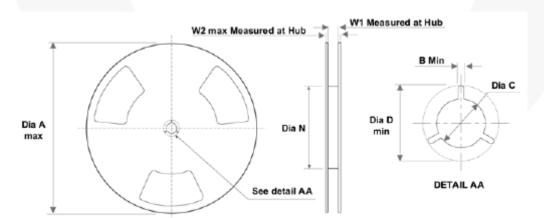
3.3 ± 0.1 2.8 ± 0.1

2.8 ± 0.1

2.8 ± 0.1 2.8 ± 0.1

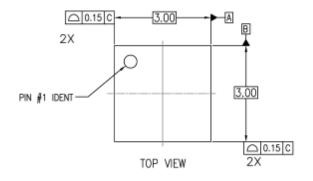
#### NOTES: unless otherwise specified

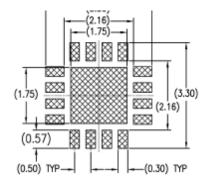
- 1. Cummulative pitch for feeding holes and cavities (chip pockets) not to exceed 0.008[0.20] over 10 pitch span.
- 2. Smallest allowable bending radius.
- 3. Thru hole inside cavity is centered within cavity.
- 4. Tolerance is  $\pm 0.002[0.05]$  for these dimensions on all 12mm tapes.
- 5. Ao and Bo measured on a plane 0.120[0.30] above the bottom of the pocket.
- 6. Ko measured from a plane on the inside bottom of the pocket to the top surface of the carrier.
- 7. Pocket position relative to sprocket hole measured as true position of pocket. Not pocket hole.
- 8. Controlling dimension is millimeter. Diemension in inches rounded.



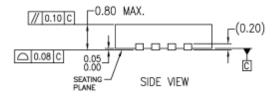
| Tape Size | Α        | В      | С       | D       | N        | W1      | W2      |
|-----------|----------|--------|---------|---------|----------|---------|---------|
|           | 13.000   | 0.059  | 0.512   | 0.795   | 7.008    | 0.488   | 0.724   |
| (12mm)    | (330.00) | (1.50) | (13.00) | (20.20) | (178.00) | (12.40) | (18.40) |

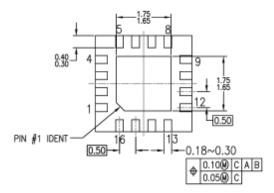
### **Package Dimensions**





RECOMMENDED LAND PATTERN





BOTTOM VIEW

#### NOTES:

- CONFORMS TO JEDEC REGISTRATION MO-220, VARIATION WEED-Pending, DATED pending
- B. DIMENSIONS ARE IN MILLIMETERS.
- C. DIMENSIONS AND TOLERANCES PER ASME Y14.5M, 1994
- D. DIMENSIONS ARE EXCLUSIVE OF BURS, MOLD FLASH, AND TIE BAR EXTRUSIONS.

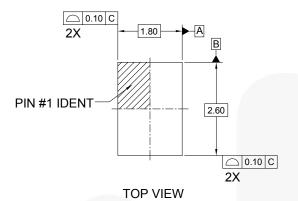
MLP16BrevB

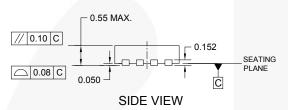
Figure 14. 16-Lead, Molded Leadless Package (MLP), JEDEC MO-220 3x3mm Square

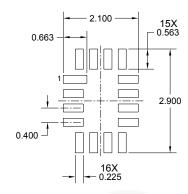
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### **Package Dimensions**

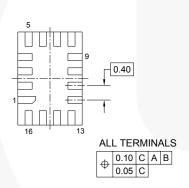


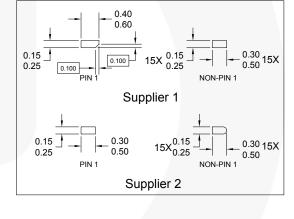




RECOMMENDED LAND PATTERN

#### TERMINAL SHAPE VARIANTS





**BOTTOM VIEW** 

#### NOTES:

- A. THIS PACKAGE IS NOT CURRENTLY REGISTERED WITH ANY STANDARDS COMMITTEE
- B. DIMENSIONS ARE IN MILLIMETERS.
- C. DIMENSIONS AND TOLERANCES PER ASME Y14.5M, 1994 D. TERMINAL SHAPE MAY VARY ACCORDING TO PACKAGE SUPPLIER, SEE TERMINAL SHAPE VARIANTS
- E. LAND PATTERN IS A MINIMAL TOE DESIGN
- F. DRAWING FILE NAME: UMLP16AREV3

Figure 15. 16-Lead, Ultrathin Molded Leadless Package (UMLP)

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#### **Definition of Terms**

| Datasheet Identification | Product Status        | Definition   |
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Rev. 134